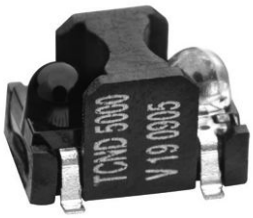
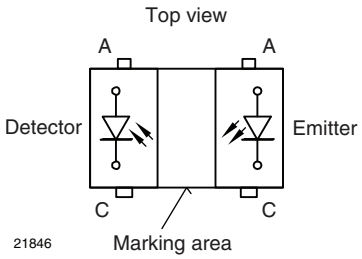
Reflective Optical Sensor with PIN Photodiode Output



19967



21846

FEATURES

- Package type: surface mount
- Detector type: pin photodiode
- Dimensions (L x W x H in mm): 6 x 4.3 x 3.75
- Peak operating distance: 6 mm
- Operating range within > 20 % relative collector current: 2 mm to 25 mm
- Typical output current under test: I_{ra} > 0.11 µA
- Daylight blocking filter
- High linearity
- Emitter wavelength: 940 nm
- Lead (Pb)-free soldering released
- Moisture sensitivity level (MSL): 4
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC

Pb-free

e3

RoHS COMPLIANT

DESCRIPTION

The TCND5000 is a reflective sensor that includes an infrared emitter and pin photodiode in a surface mount package which blocks visible light.

APPLICATIONS

- Proximity sensor
- Object sensor
- Motion sensor
- Touch key

PRODUCT SUMMARY				
PART NUMBER	DISTANCE FOR MAXIMUM CTR_{rel} (1) (mm)	DISTANCE RANGE FOR RELATIVE I_{out} > 20 % (mm)	TYPICAL OUTPUT CURRENT UNDER TEST (2) (mA)	DAYLIGHT BLOCKING FILTER INTEGRATED
TCND5000	6	2 to 25	0.15	Yes

Notes

(1) CTR: current transfere ratio, I_{out}/I_{in}

(2) Conditions like in table basic charactristics/sensors

ORDERING INFORMATION			
ORDERING CODE	PACKAGING	VOLUME (1)	REMARKS
TCND5000	Tape and reel	MOQ: 2000 pcs, 2000 pcs/reel	Drypack

Note

(1) MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T_{amb} = 25 °C, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
INPUT (EMITTER)				
Reverse voltage		V_R	5	V
Forward current		I_F	100	mA
Peak forward current	t_p = 50 µs, t = 2 ms, $T_{amb} \leq$ 25 °C	I_{FM}	500	mA
Power dissipation		P_V	190	mW
Junction temperature		T_j	100	°C

ABSOLUTE MAXIMUM RATINGS (T_{amb} = 25 °C, unless otherwise specified)				
PARAMETER	**TEST CONDITION**	**SYMBOL**	**VALUE**	**UNIT**
OUTPUT (DETECTOR)				
Reverse voltage		V_R	60	V
Power dissipation		P_V	75	mW
Junction temperature		T_j	100	°C
SENSOR				
Ambient temperature range		T_{amb}	- 40 to + 85	°C
Storage temperature range		T_{stg}	- 40 to + 100	°C
Soldering temperature	acc. fig. 14	T_{sd}	260	°C

ABSOLUTE MAXIMUM RATINGS

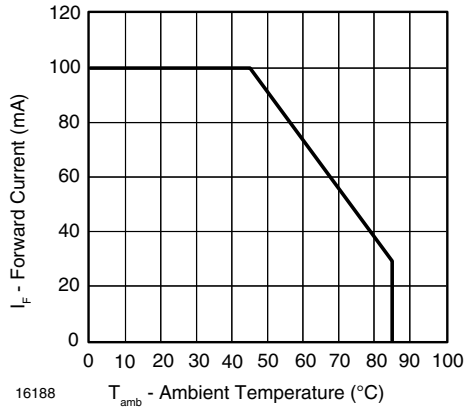


Fig. 1 - Forward Current Limit vs. Ambient Temperature

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)						
PARAMETER	**TEST CONDITION**	**SYMBOL**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
INPUT (EMITTER) (1)						
Forward voltage	I_F = 50 mA, t_p = 20 ms	V_F		1.2	1.5	V
Temperature coefficient of V_F	I_F = 1 mA	TK_{VF}		- 1.3		mV/K
Reverse current	V_R = 5 V	I_R			10	µA
Junction capacitance	V_R = 0 V, f = 1 MHz, E = 0 lx	C_j		25		pF
Radiant intensity	I_F = 20 mA, t_p = 20 ms	I_e		7	75	mW/sr
Angle of half intensity		φ		± 12		deg
Peak wavelength	I_F = 100 mA	λ_P	930	940		nm
Spectral bandwidth	I_F = 100 mA	$\Delta\lambda$		50		nm
Temperature coefficient of λ_p	I_F = 100 mA	$TK\lambda_P$		0.2		nm/K
Rise time	I_F = 100 mA	t_r		800		ns
Fall time	I_F = 100 mA	t_f		800		ns
Virtual source diameter	Method: 63 % encircled energy	d		1.2		mm

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)						
PARAMETER	**TEST CONDITION**	**SYMBOL**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
OUTPUT (DETECTOR) (2)						
Forward voltage	I_F = 50 mA	V_F		1	1.3	V
Breakdown voltage	I_R = 100 µA	V_{BR}	60			V
Reverse dark current	V_R = 10 V, E = 0 lx	I_{ro}		1	10	nA
Diode capacitance	V_R = 5 V, f = 1 MHz, E = 0 lx	C_D		1.8		pF
Reverse light current	E_e = 1 mW/cm², λ = 950 nm, V_R = 5 V	I_{ra}		12		µA
Temperature coefficient of I_{ra}	λ = 870 nm, V_R = 5 V	TK_{ira}		0.2		%/K
Angle of half intensity		φ		± 15		deg
Wavelength of peak sensitivity		λ_P		930		nm
Range of spectral bandwidth		$\lambda_{0.5}$		840 to 1050		nm
SENSOR						
Reverse Light Current	V_R = 2.5 V, I_F = 20 mA, D = 30 mm, reflective mode: see figure 2	I_{ra}	110			nA

Note

(1) See figures 2 to 8 accordingly

(2) See figures 9 to 12 accordingly

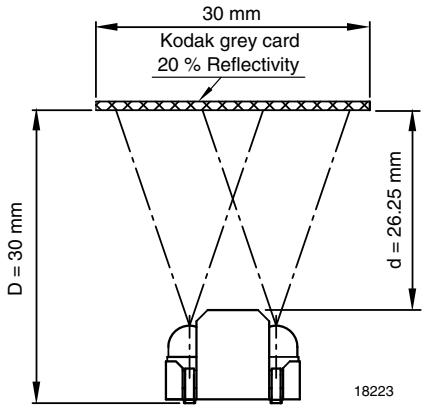


Fig. 2 - Test Circuit

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

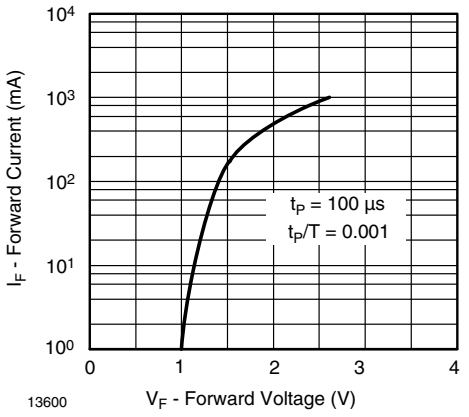


Fig. 3 - Forward Current vs. Forward Voltage

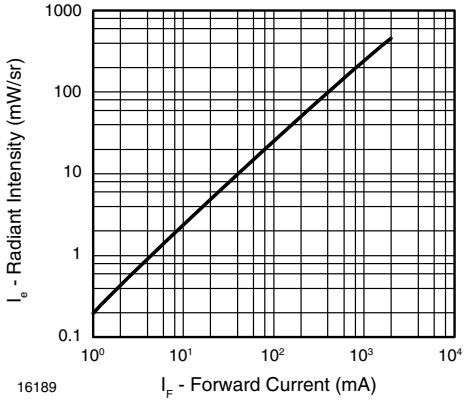


Fig. 4 - Radiant Intensity vs. Forward Current

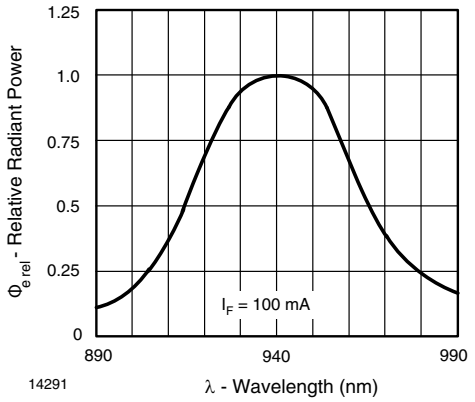


Fig. 5 - Relative Radiant Power vs. Wavelength

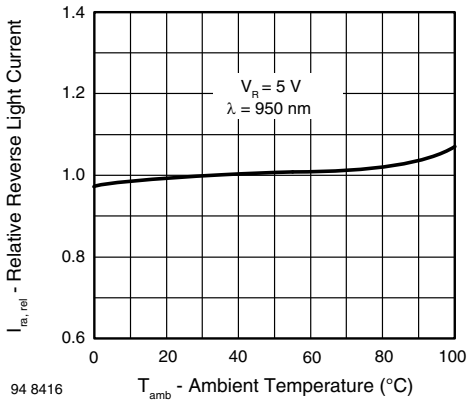


Fig. 8 - Relative Reverse Light Current vs. Ambient Temperature

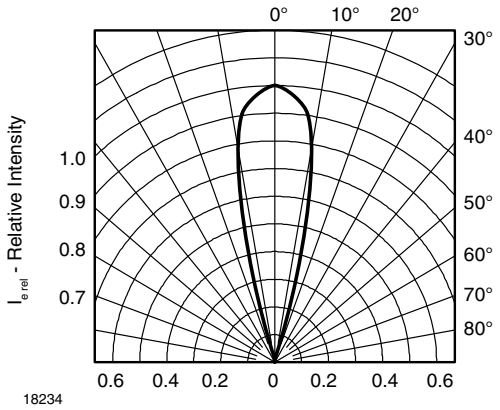


Fig. 6 - Relative Radiant Intensity vs. Angular Displacement

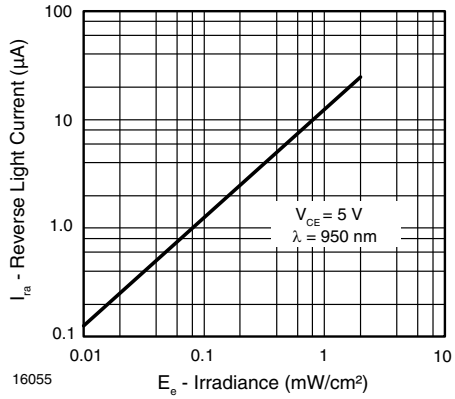


Fig. 9 - Reverse Light Current vs. Irradiance

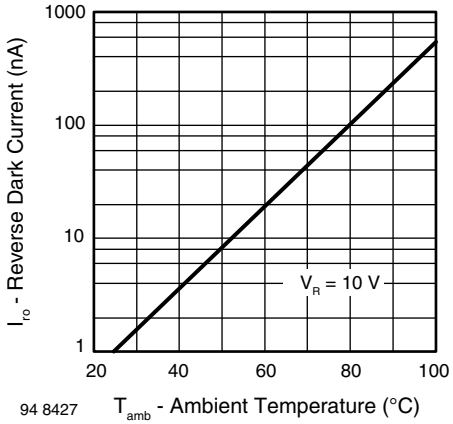


Fig. 7 - Reverse Dark Current vs. Ambient Temperature

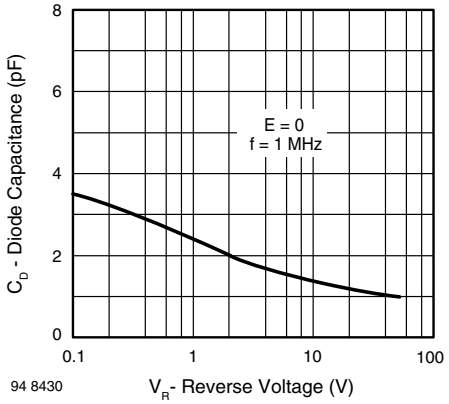


Fig. 10 - Diode Capacitance vs. Reverse Voltage

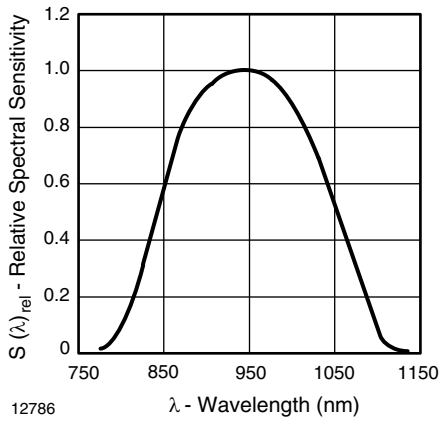


Fig. 11 - Relative Spectral Sensitivity vs. Wavelength

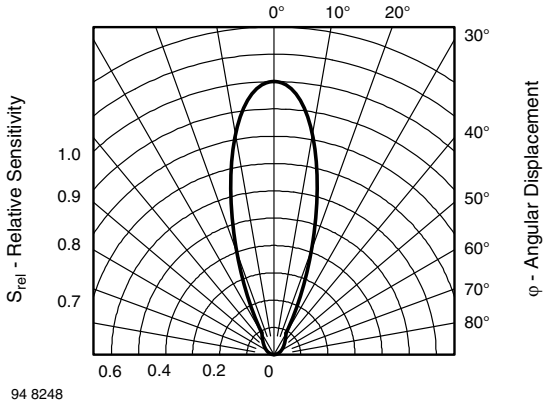


Fig. 12 - Relative Radiant Sensitivity vs. Angular Displacement

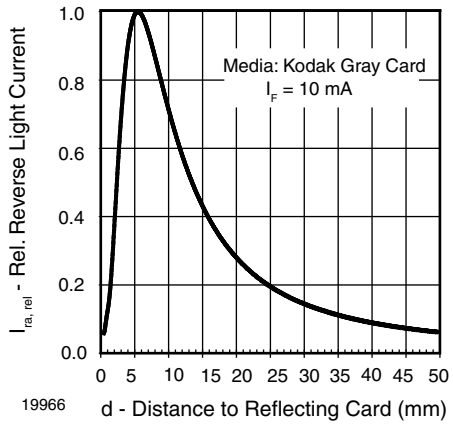
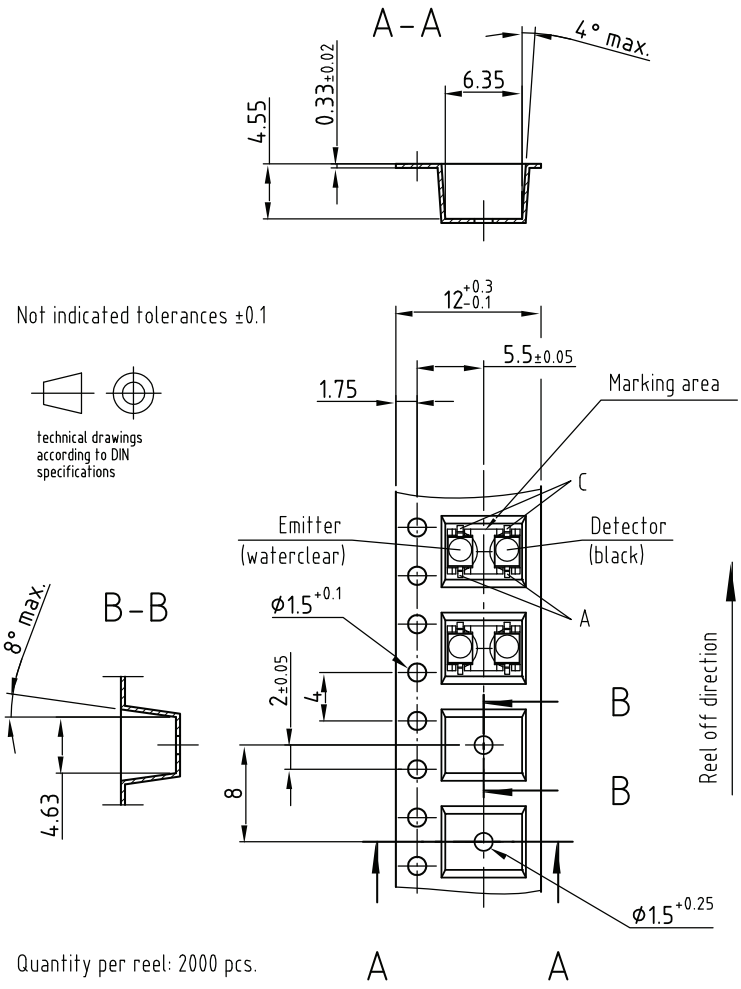


Fig. 13 - Relative Reverse Light Current vs. Distance

TAPING Dimensions in millimeters

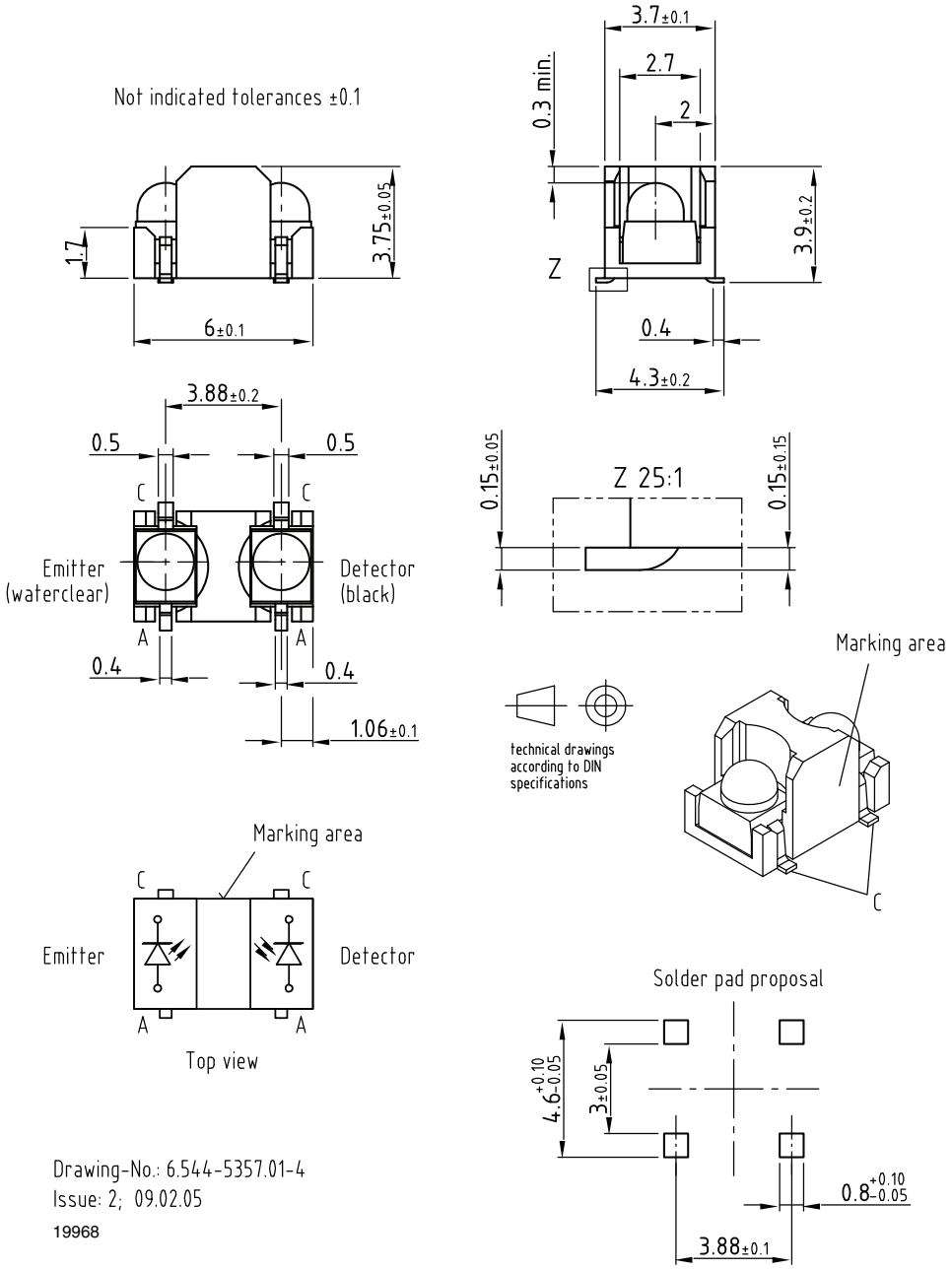


Quantity per reel: 2000 pcs.

Material of Blistertape: PC black
Sealing of cavities with hot sealing cover tape,
C-Pak Type CP - 2010 AS (Thickness: 0.055 - 0.075mm; Base Material: Polyester)

Drawing-No.: 9.700-5281.01-4
Issue: 4; 10.02.05
18222

PACKAGE DIMENSIONS in millimeters



Drawing-No.: 6.544-5357.01-4
Issue: 2; 09.02.05
19968

PRECAUTIONS FOR USE

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

2.1 Storage temperature and rel. humidity conditions are: 5 °C to 30 °C, RH 60 %
2.2 Floor life must not exceed 72 h, acc. to JEDEC level 4, J-STD-020.
Once the package is opened, the products should be used within 72 h. Otherwise, they should be kept in a damp proof box with desiccant.
Considering tape life, we suggest to use products within one year from production date.
2.3 If opened more than 72 h in an atmosphere 5 °C to 30 °C, RH 60 %, devices should be treated at 60 °C ± 5 °C for 15 h.
2.4 If humidity indicator in the package shows pink color (normal blue), then devices should be treated with the same conditions as 2.3

REFLOW SOLDER PROFILES

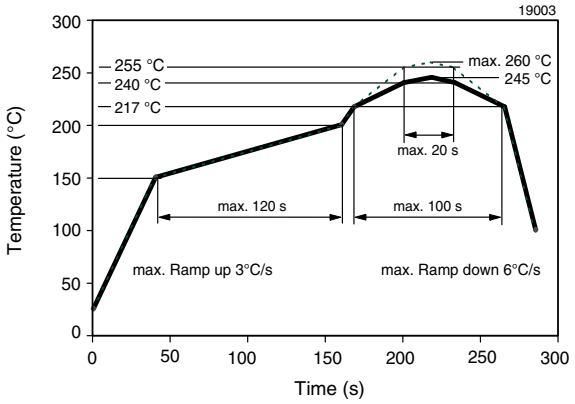


Fig. 14 - Lead (Pb)-Free Reflow Solder Profile

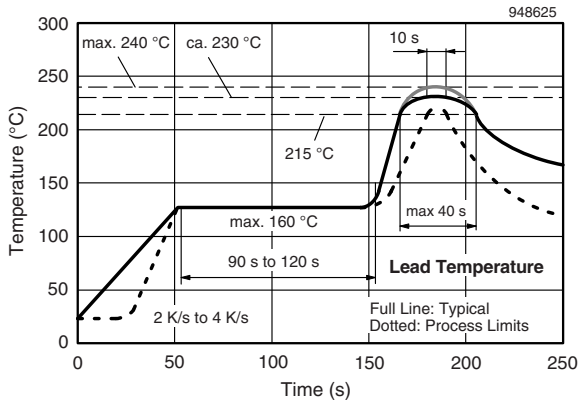


Fig. 15 - Lead Tin (SnPb) Reflow Solder Profile

Packaging and Ordering Information

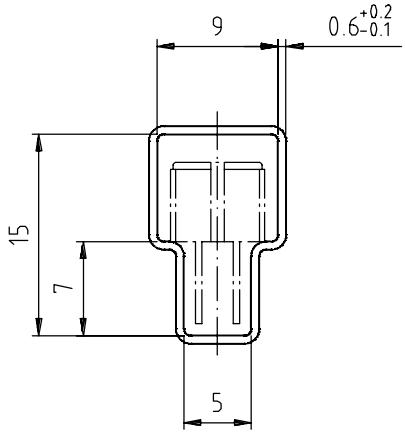
PART NUMBER	MOQ (1)	PCS PER TUBE	TUBE SPEC. (FIGURE)	CONSTITUENTS (FORMS)
CNY70	4000	80	1	28
TCPT1300X01	2000	Reel	(2)	29
TCRT1000	1000	Bulk	-	26
TCRT1010	1000	Bulk	-	26
TCRT5000	4500	50	2	27
TCRT5000L	2400	48	3	27
TCST1030	5200	65	5	24
TCST1030L	2600	65	6	24
TCST1103	1020	85	4	24
TCST1202	1020	85	4	24
TCST1230	4800	60	7	24
TCST1300	1020	85	4	24
TCST2103	1020	85	4	24
TCST2202	1020	85	4	24
TCST2300	1020	85	4	24
TCST5250	4860	30	8	24
TCUT1300X01	2000	Reel	(2)	29
TCZT8020-PAER	2500	Bulk	-	22

Notes

(1) MOQ: minimum order quantity

(2) Please refer to datasheets

TUBE SPECIFICATION FIGURES

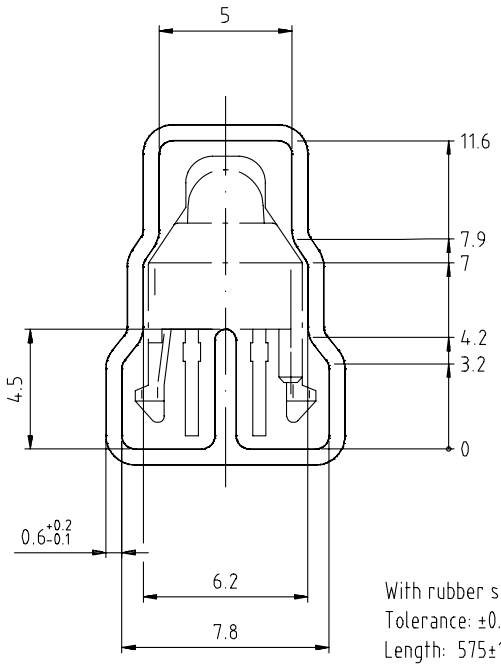


With rubber stopper
Tolerance: ±0.5mm
Length: 575±1mm

Drawing-No.: 9.700-5097.01-4
Issue: 1; 25.02.00

15198

Fig. 1



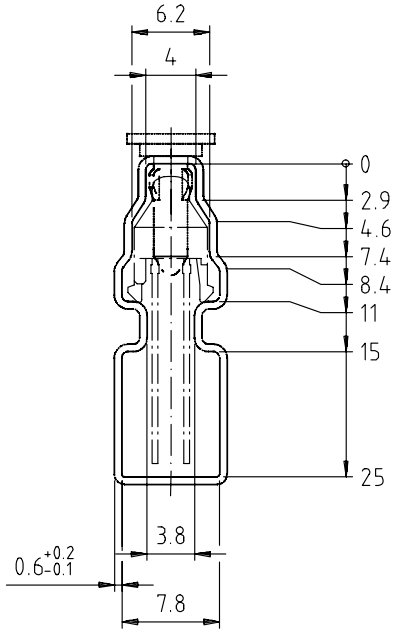
Drawing-No.: 9.700-5139.01-4
Issue: 1; 10.05.00

With rubber stopper
Tolerance: ±0.5mm
Length: 575±1mm

Drawing refers to following types: TCRT 5000

15210

Fig. 2

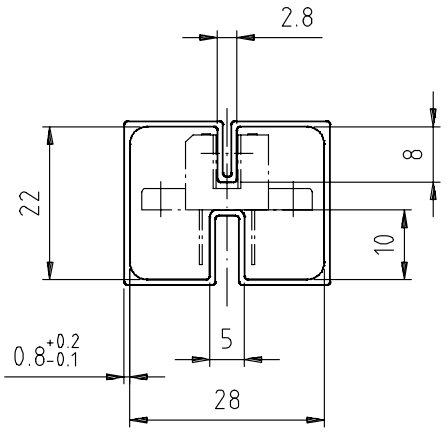


With stopper pins
Tolerance: ±0.5mm
Length: 575±1mm

Drawing-No.: 9.700-5178.01-4
Issue: 1; 25.02.00

15201

Fig. 3

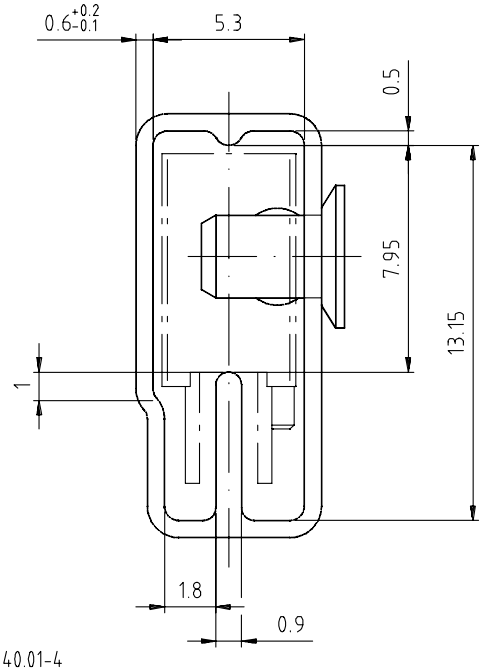


With rubber stopper
Tolerance: ±0.5mm
Length: 575±1mm

Drawing-No.: 9.700-5100.01-4
Issue: 1; 25.02.00

15199

Fig. 4



With stopper pins
Tolerance: ±0.5mm
Length: 575±1mm

Drawing-No.: 9.700-5140.01-4
Issue: 1; 25.02.00

15202

Fig. 5

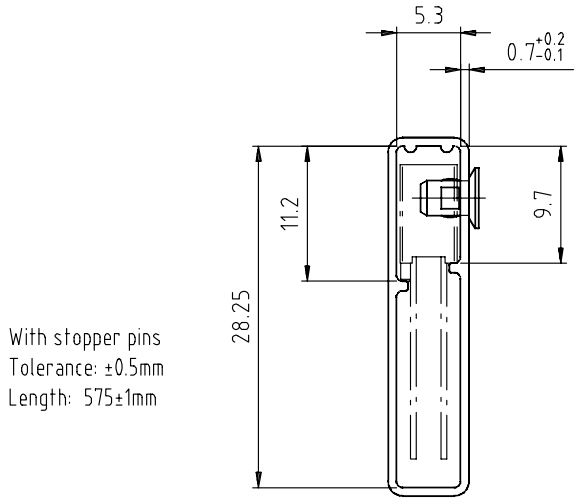

5.3
0.7+0.2-0.1
11.2
9.7
28.25
With stopper pins
Tolerance: ±0.5mm
Length: 575±1mm
Drawing-No.: 9.700-5205.01-4
Issue: 1; 25.02.00
15196

Fig. 6

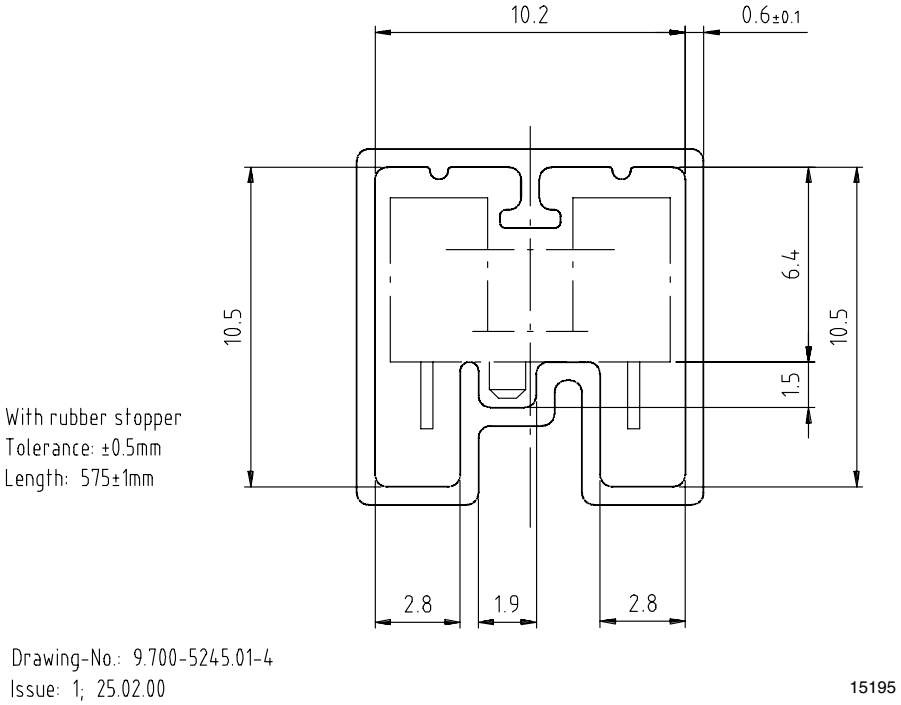
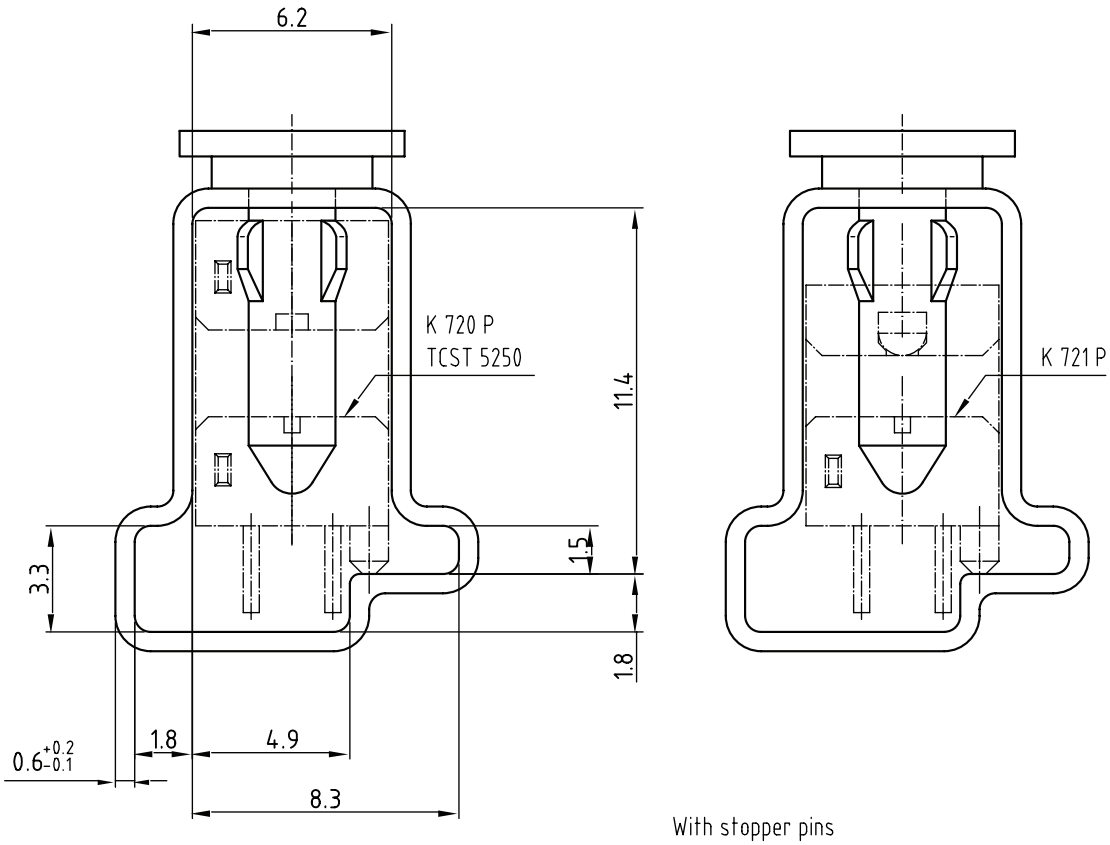

10.2
0.6±0.1
10.5
6.4
10.5
1.5
With rubber stopper
Tolerance: ±0.5mm
Length: 575±1mm
2.8
1.9
2.8
Drawing-No.: 9.700-5245.01-4
Issue: 1; 25.02.00
15195

Fig. 7



Drawing-No.: 9.700-5222.01-4
Issue: 2; 19.11.04
20257

With stopper pins
Tolerance: ±0.5mm
Length: 450±1mm
All dimensions in mm

Fig. 8

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Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.